

EVALUATION KIT
AVAILABLE

MAXIM

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

General Description

The MAX5927/MAX5929 +1V to +13.2V quad hot-swap controllers provide complete protection for multisupply systems. They allow the safe insertion and removal of circuit cards into live backplanes. These devices hot swap multiple supplies ranging from +1V to +13.2V, provided one supply is at or above +2.7V and only one supply is above +11.0V. The input voltage rails (channels) can be configured to sequentially turn-on/off, track each other, or have completely independent operation.

The discharged filter capacitors of the circuit card provide low impedance to the live backplane. High inrush currents from the backplane to the circuit card can burn up connectors and components, or momentarily collapse the backplane power supply leading to a system reset. The MAX5927/MAX5929 hot-swap controllers prevent such problems by gradually ramping up the output voltage and regulating the current to a preset limit when the board is plugged in, allowing the system to stabilize safely. After the startup cycle is complete, on-chip comparators provide VariableSpeed/BiLevel™ protection against short-circuit and overcurrent faults, and provide immunity against system noise and load transients. The load is disconnected in the event of a fault condition. The MAX5929A automatically restarts after a fault condition, while the MAX5929L must be unlatched. The MAX5927 fault management mode is selectable.

The MAX5927/MAX5929 offer a variety of options to reduce external component count and design time. All devices integrate an on-board charge pump to drive the gates of low-cost external N-channel MOSFETs, an adjustable startup timer, and an adjustable current limit. The devices offer integrated features like startup current regulation and current glitch protection to eliminate external timing resistors and capacitors. The MAX5929_L provides an open-drain active-low status output for each channel, the MAX5929_H provides an open-drain active-high status output for each channel, and the MAX5927 status output polarity is selectable.

The MAX5927 is available in a 32-pin thin QFN package and the MAX5929 is available in a 24-pin QSOP package. All devices are specified over the extended temperature range, -40°C to +85°C.

Applications

| | |
|----------------------------------|--|
| PCI Express Hot Plug | Basestation Line Cards |
| Hot Plug-In Daughter Cards | Portable Computer Device Bays (Docking Stations) |
| RAID | Network Switches, Routers, Hubs |
| Power-Supply Sequencing/Tracking | |

VariableSpeed/BiLevel is a trademark of Maxim Integrated Products, Inc.

Features

- ♦ Safe Hot Swap for +1V to +13.2V Power Supplies with Any Input Voltage ($V_{IN} \geq 2.7V$ and Only One $V_{IN} > 11.0V$)
- ♦ Adjustable Circuit Breaker/Current-Limit Threshold from 25mV to 100mV
- ♦ Configurable Tracking, Sequencing, or Independent Operation Modes
- ♦ VariableSpeed/BiLevel Circuit-Breaker Response
- ♦ Internal Charge Pumps Generate N-Channel MOSFET Gate Drives
- ♦ Inrush Current Regulated at Startup
- ♦ Autoretry or Latched Fault Management
- ♦ Programmable Undervoltage Lockout
- ♦ Status Outputs Indicate Fault/Safe Condition

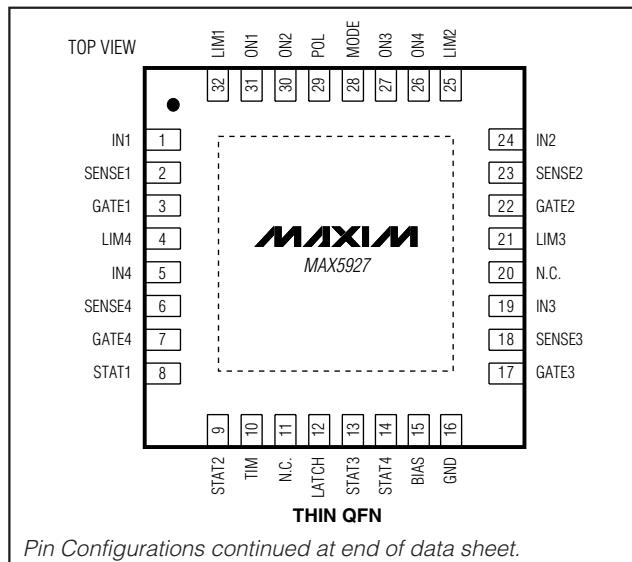
Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|---------------------|----------------|----------------|
| MAX5927ETJ | -40°C to +85°C | 32 Thin QFN-EP |
| MAX5929LHEEG | -40°C to +85°C | 24 QSOP |
| MAX5929LLEEG | -40°C to +85°C | 24 QSOP |
| MAX5929AHEEG | -40°C to +85°C | 24 QSOP |
| MAX5929ALEEG | -40°C to +85°C | 24 QSOP |

EP = Exposed paddle.

Selector Guide and Typical Operating Circuit appear at end of data sheet.

Pin Configurations



Pin Configurations continued at end of data sheet.

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ABSOLUTE MAXIMUM RATINGS

| | |
|--|-----------------------|
| (All voltages referenced to GND, unless otherwise noted.) | |
| IN_ | -0.3V to +14V |
| GATE_ | -0.3V to (IN_ + 6V) |
| BIAS (Note 1) | (VIN - 0.3V) to +14V |
| ON_, STAT_, LIM_ (MAX5927), TIM, MODE, LATCH (MAX5927), POL (MAX5927) | |
| (Note 1) | -0.3V to (VIN + 0.3V) |
| SENSE_ | -0.3V to (IN_ + 0.3V) |
| Current into Any Pin | ±50mA |

Note 1: VIN is the largest of VIN1, VIN2, VIN3, and VIN4.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(VIN_ = +1V to +13.2V provided at least one supply is larger than or equal to +2.7V and only one supply is > +11.0V, TA = -40°C to +85°C, unless otherwise noted. Typical values are at VIN1 = 12.0V, VIN2 = 5.0V, VIN3 = 3.3V, VIN4 = 1.0V, VON_ = +3.3V, and TA = +25°C.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|----------------------|--|---------------------|------|---|-------|
| POWER SUPPLIES | | | | | | |
| IN_ Input Voltage Range | VIN_ | At least one VIN_ ≥ +2.7V and only one VIN_ > +11.0V | 1.0 | 13.2 | | V |
| Supply Current | IQ | IN1 + IN2 + IN3 + IN4, VON_ = 2.7V, VIN_ = +13.2V, after STAT_ asserts | 2.5 | 5 | | mA |
| CURRENT CONTROL | | | | | | |
| Slow-Comparator Threshold (VIN_ - VSENSE_) (Note 3) | VSC,TH | LIM_ = GND, MAX5927/MAX5929 (Note 4) | TA = +25°C | 22.5 | 25 | 27.5 |
| | | | TA = -40°C to +85°C | 21.0 | | 27.5 |
| | | R _{LIM} = 10kΩ (MAX5927) | | 80 | | 125 |
| | | R _{LIM} from LIM_ to GND (MAX5927) | | | R _{LIM} × 7.5 × 10 ⁻⁶ + 25mV | |
| Slow-Comparator Response Time (Note 4) | tSCD | 1mV overdrive | | 3 | | ms |
| | | 50mV overdrive | | 130 | | μs |
| Fast-Comparator Threshold (VIN_ - VSENSE_) | VFC,TH | | | 2 × | V _{SC,TH} | mV |
| Fast-Comparator Response Time | tFCD | 10mV overdrive, from overload condition | | 200 | | ns |
| SENSE_ Input Bias Current | I _{B SENSE} | VSENSE_ = VIN_ | 0.03 | 1 | | μA |
| MOSFET DRIVER | | | | | | |
| Startup Period (Note 5) | t _{START} | R _{TIM} = 100kΩ | 8.0 | 10.8 | 13.6 | ms |
| | | R _{TIM} = 4kΩ (minimum value) | 0.30 | 0.4 | 0.55 | |
| | | TIM floating (default) | 5 | 9 | 14 | |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{IN_} = +1V$ to $+13.2V$ provided at least one supply is larger than or equal to $+2.7V$ and only one supply is $> +11.0V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $V_{IN1} = 12.0V$, $V_{IN2} = 5.0V$, $V_{IN3} = 3.3V$, $V_{IN4} = 1.0V$, $V_{ON_} = +3.3V$, and $T_A = +25^{\circ}C$.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--------------------------------------|------------------------|---|------|-------|-----------------|-------|
| Average Gate Current | I _{GATE} | Charging, $V_{GATE_} = GND$, $V_{IN_} = 5V$ (Note 6) | 80 | 100 | 125 | μA |
| | | Discharging, during startup | | 100 | | |
| | | Discharging, normal turn-off or triggered by the slow comparator after startup, $V_{GATE_} = 5V$, $V_{IN_} = 10V$, $V_{ON_} = 0V$ | 2 | 3 | 7 | mA |
| | | Discharging, triggered by a fault after startup, $V_{GATE_} = 5V$, $V_{IN_} = 10V$, $(V_{IN_} - V_{SENSE_}) > V_{FC,TH}$ (Note 7) | 30 | 50 | 120 | |
| Gate-Drive Voltage | V _{DRIVE} | $V_{GATE_} - V_{IN_}$, $I_{GATE_} = 1\mu A$ | 4.9 | 5.3 | 5.6 | V |
| ON COMPARATOR | | | | | | |
| ON_ Threshold | V _{ON,TH} | Low to high | 0.85 | 0.875 | 0.90 | V |
| | | Hysteresis | | 25 | | mV |
| ON_ Propagation Delay | | 10mV overdrive | | 10 | | μs |
| ON_ Voltage Range | V _{ON} | Without false output inversion | | | V _{IN} | V |
| ON_ Input Bias Current | I _{BON} | $V_{ON_} = V_{IN}$ | | 0.03 | 1 | μA |
| ON_ Pulse Width Low | t _{UNLATCH} | To unlatch after a latched fault | 100 | | | μs |
| DIGITAL OUTPUTS (STAT_) | | | | | | |
| Output Leakage Current | | $V_{STAT_} \leq 13.2V$ | | 1 | | μA |
| Output Voltage Low | V _{OL} | POL = floating (MAX5927), $I_{SINK} = 1mA$ | | 0.4 | | V |
| UNDERVOLTAGE LOCKOUT (UVLO) | | | | | | |
| UVLO Threshold | V _{UVLO} | Startup is initiated when this threshold is reached by any $V_{IN_}$ and $V_{ON_} > 0.9V$ (Note 8) | 2.25 | | 2.65 | V |
| UVLO Hysteresis | V _{UVLO,HYST} | | 250 | | | mV |
| UVLO Glitch Filter Reset Time | t _{D,GF} | $V_{IN} < V_{UVLO}$ maximum pulse width to reset | | 10 | | μs |
| UVLO to Startup Delay | t _{D,UVLO} | Time input voltage must exceed V_{UVLO} before startup is initiated | 20 | 37.5 | 60 | ms |
| Input Power-Ready Threshold | V _{PWRRDY} | (Note 9) | 0.9 | 0.95 | 1.0 | V |
| Input Power-Ready Hysteresis | V _{PWRHYST} | | 50 | | | mV |
| LOGIC AND TIMING | | | | | | |
| POL Input Pullup | I _{POL} | POL = GND (MAX5927) | 2 | 4 | 6 | μA |
| LATCH Input Pullup | I _{LATCH} | LATCH = GND (MAX5927) | 2 | 4 | 6 | μA |
| MODE Input Voltage | V _{MODE} | MODE floating (default to sequencing mode) | 1.0 | 1.25 | 1.5 | V |
| Independent Mode Selection Threshold | V _{INDEP, TH} | V _{MODE} rising | | 0.4 | | V |
| Tracking Mode Selection Threshold | V _{TRACK, TH} | V _{MODE} rising | 2.7 | | | V |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{IN_} = +1V$ to $+13.2V$ provided at least one supply is larger than or equal to $+2.7V$ and only one supply is $> +11.0V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $V_{IN1} = 12.0V$, $V_{IN2} = 5.0V$, $V_{IN3} = 3.3V$, $V_{IN4} = 1.0V$, $V_{ON_} = +3.3V$, and $T_A = +25^{\circ}C$.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|----------------------|-------------|--|------|-------------|-----|-----------|
| MODE Input Impedance | R_{MODE} | | 200 | | | $k\Omega$ |
| Autoretry Delay | t_{RETRY} | Delay time to restart after fault shutdown | 64 x | t_{START} | | ms |

Note 2: All devices are 100% tested at $T_A = +25^{\circ}C$. Limits over temperature are guaranteed by design.

Note 3: The slow-comparator threshold is adjustable. $V_{SC,TH} = RLIM \times 7.5\mu A + 25mV$ (see the *Typical Operating Characteristics*).

Note 4: The current-limit slow-comparator response time is weighed against the amount of overcurrent—the higher the overcurrent condition, the faster the response time (see the *Typical Operating Characteristics*).

Note 5: The startup period (t_{START}) is the time during which the slow comparator is ignored and the device acts as a current limiter by regulating the sense current with the fast comparator (see the *Startup Period* section).

Note 6: The current available at GATE is a function of V_{GATE} (see the *Typical Operating Characteristics*).

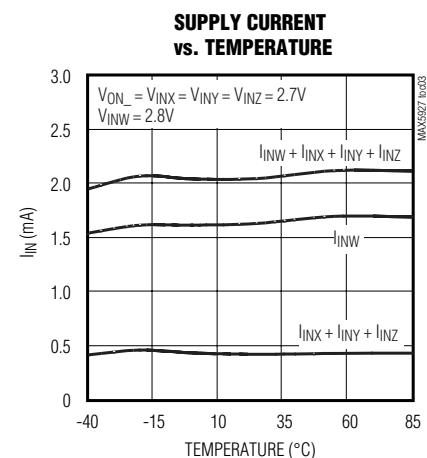
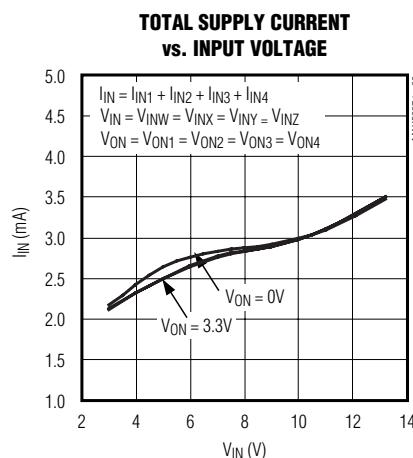
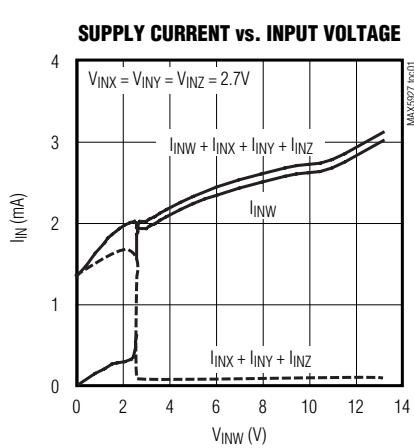
Note 7: After a fault triggered by the fast comparator, the gate is discharged by the strong discharge current.

Note 8: Each channel input while the other inputs are at $+1V$.

Note 9: Each channel input while any other input is at $+3.3V$.

Typical Operating Characteristics

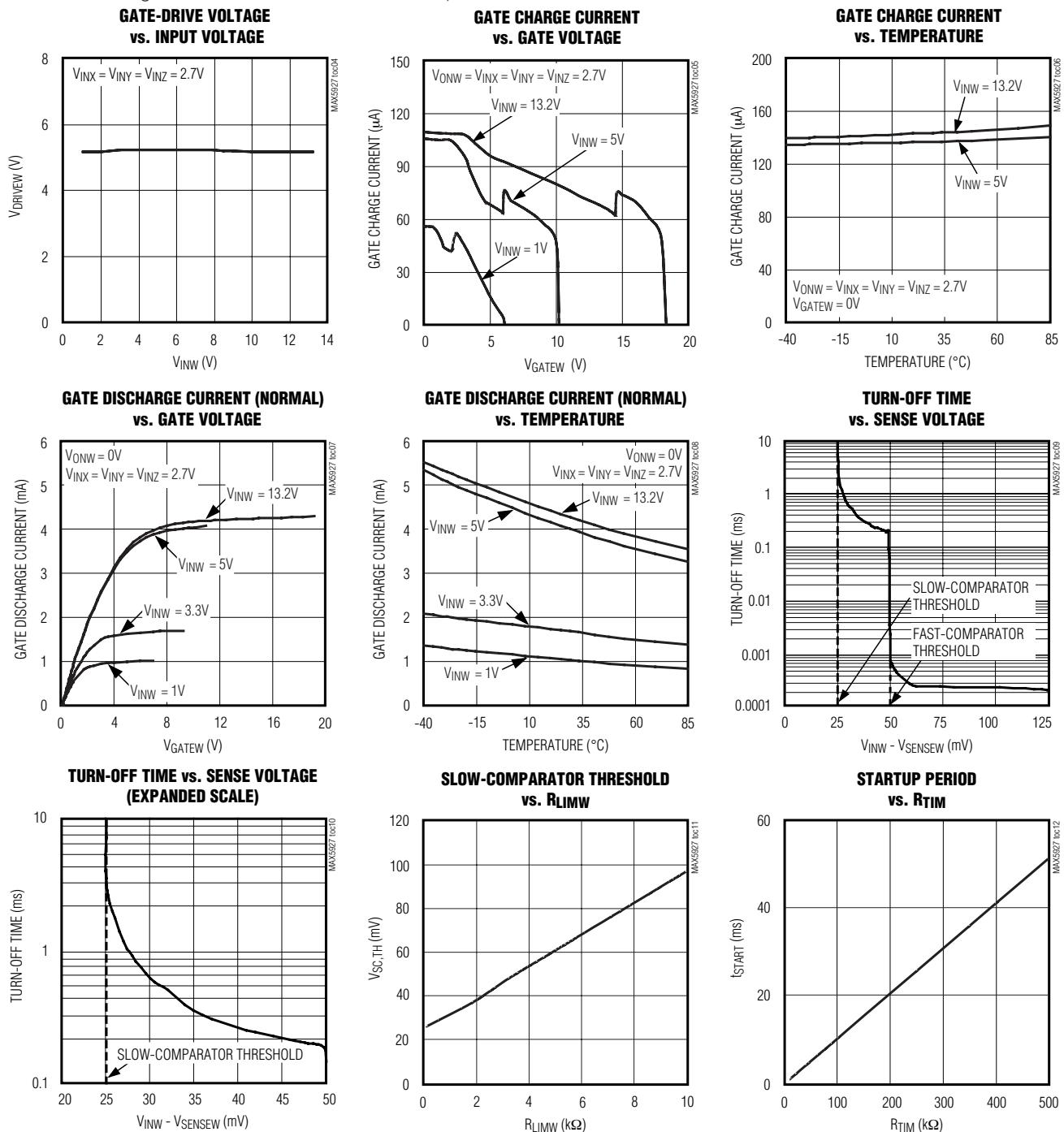
(Typical Operating Circuits, $Q1 = Q2 = Q3 = Q4 =$ Fairchild FDB7090L, $V_{IN1} = 12V$, $V_{IN2} = 5.0V$, $V_{IN3} = 3.3V$, $V_{IN4} = 1.0V$, $T_A = +25^{\circ}C$, unless otherwise noted. Channels 1 through 4 are identical in performance. Where characteristics are interchangeable, channels 1 through 4 are referred to as W, X, Y, and Z.)



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Typical Operating Characteristics (continued)

(Typical Operating Circuits, Q1 = Q2 = Q3 = Q4 = Fairchild FDB7090L, $V_{IN1} = 12V$, $V_{IN2} = 5.0V$, $V_{IN3} = 3.3V$, $V_{IN4} = 1.0V$, $T_A = +25^\circ C$, unless otherwise noted. Channels 1 through 4 are identical in performance. Where characteristics are interchangeable, channels 1 through 4 are referred to as W, X, Y, and Z.)

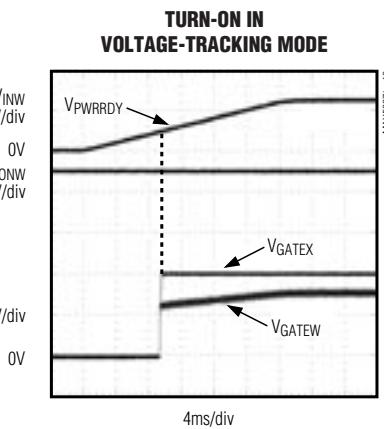
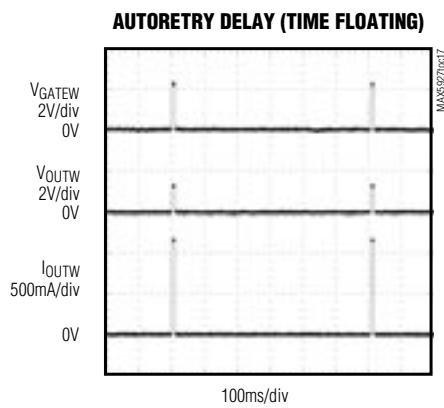
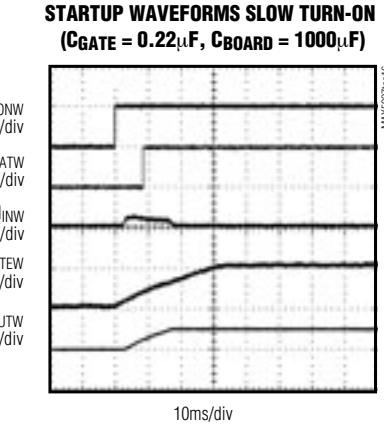
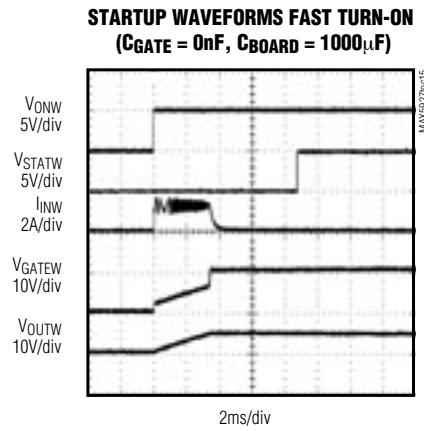
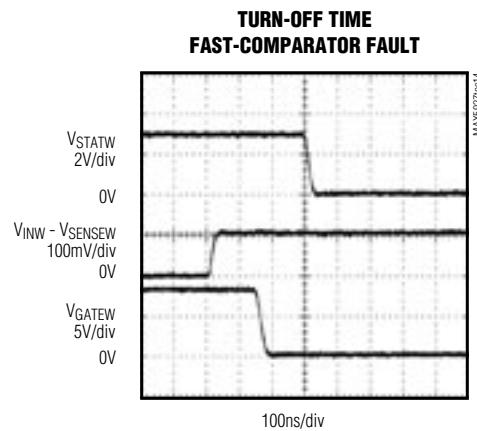
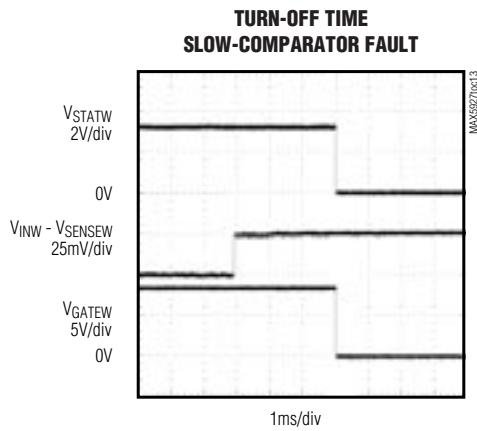


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Typical Operating Characteristics (continued)

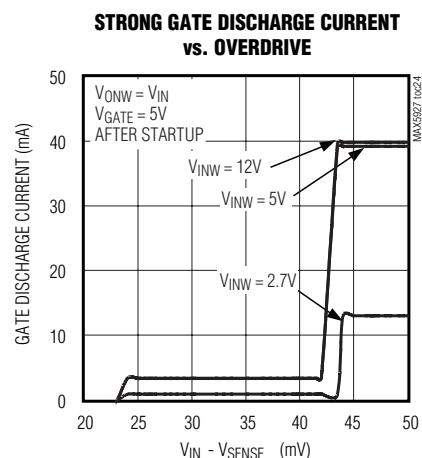
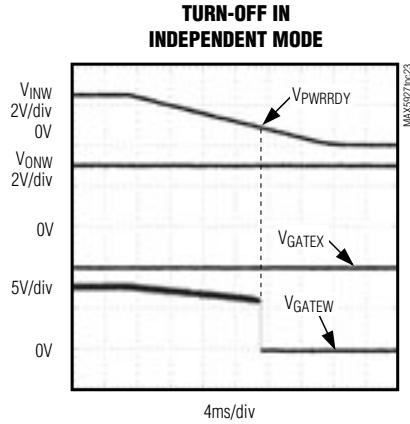
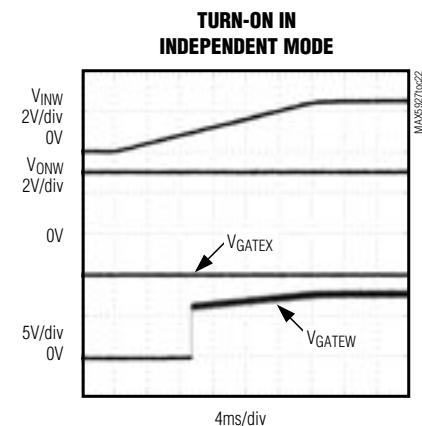
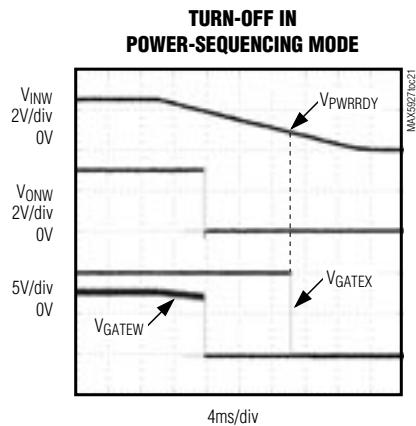
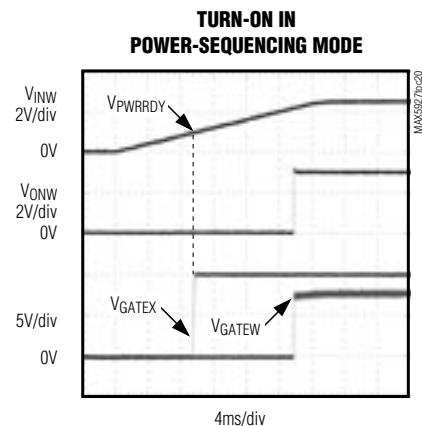
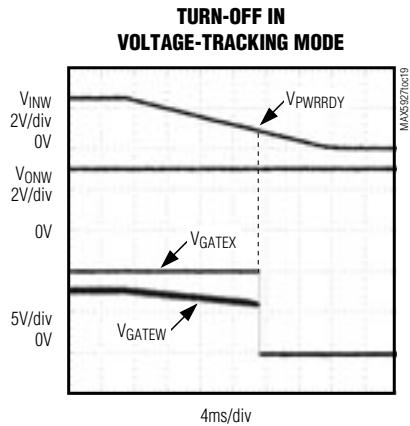
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Typical Operating Characteristics (continued)

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Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Pin Description

| PIN | | NAME | FUNCTION |
|---------|---------|--------|--|
| MAX5927 | MAX5929 | | |
| 1 | 4 | IN1 | Channel 1 Supply Input. Connect to a supply voltage from 1V to 13.2V and to one end of RSENSE1. Bypass with a 0.1 μ F capacitor to ground. |
| 2 | 5 | SENSE1 | Channel 1 Current-Sense Input. Connect SENSE1 to the drain of an external MOSFET and to one end of RSENSE1. |
| 3 | 6 | GATE1 | Channel 1 Gate-Drive Output. Connect to gate of external N-channel MOSFET. |
| 4 | — | LIM4 | Channel 4 Current-Limit Setting. Connect a resistor from LIM4 to GND to set current-trip level. Connect to GND for the default 25mV threshold. Do not leave open. |
| 5 | 7 | IN4 | Channel 4 Supply Input. Connect to a supply voltage from 1V to 13.2V and to one end of RSENSE4. Bypass with a 0.1 μ F capacitor to ground. |
| 6 | 8 | SENSE4 | Channel 4 Current-Sense Input. Connect SENSE4 to the drain of an external MOSFET and to one end of RSENSE4. |
| 7 | 9 | GATE4 | Channel 4 Gate-Drive Output. Connect to gate of external N-channel MOSFET. |
| 8 | 10 | STAT1 | Open-Drain Status Signal for Channel 1. STAT1 asserts when hot swap is successful and tSTART has elapsed. STAT1 deasserts if ON1 is low, or if channel 1 is turned off for any fault condition. |
| 9 | 11 | STAT2 | Open-Drain Status Signal for Channel 2. STAT2 asserts when hot swap is successful and tSTART has elapsed. STAT2 deasserts if ON2 is low, or if channel 2 is turned off for any fault condition. |
| 10 | 12 | TIM | Startup Timer Setting. Connect a resistor from TIM to GND to set the startup period. Leave TIM unconnected for the default startup period of 9ms. RTIM must be between 4k Ω and 500k Ω . |
| 11, 20 | — | N.C. | No Connection. Not internally connected. |
| 12 | — | LATCH | Latch/Autoretry Selection Input. Connect LATCH to GND for autoretry mode after a fault. Leave LATCH open for latch mode. |
| 13 | 13 | STAT3 | Open-Drain Status Signal for Channel 3. STAT3 asserts when hot swap is successful and tSTART has elapsed. STAT3 deasserts if ON3 is low, or if channel 3 is turned off for any fault condition. |
| 14 | 14 | STAT4 | Open-Drain Status Signal for Channel 4. STAT4 asserts when hot swap is successful and tSTART has elapsed. STAT4 deasserts if ON4 is low, or if channel 4 is turned off for any fault condition. |
| 15 | 15 | BIAS | Supply Reference Output. The highest supply is available at BIAS for filtering. Connect a 1nF to 10nF ceramic capacitor from BIAS to GND. No other connections are allowed to this pin. |
| 16 | 16 | GND | Ground |
| 17 | 17 | GATE3 | Channel 3 Gate-Drive Output. Connect to gate of external N-channel MOSFET. |
| 18 | 18 | SENSE3 | Channel 3 Current-Sense Input. Connect SENSE3 to the drain of an external MOSFET and to one end of RSENSE3. |
| 19 | 19 | IN3 | Channel 3 Supply Input. Connect to a supply voltage from 1V to 13.2V and to one end of RSENSE3. |

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Pin Description (continued)

| PIN | | NAME | FUNCTION |
|---------|---------|--------|---|
| MAX5927 | MAX5929 | | |
| 21 | — | LIM3 | Channel 3 Current-Limit Setting. Connect a resistor from LIM3 to GND to set current-trip level. Connect to GND for the default 25mV threshold. Do not leave open. |
| 22 | 20 | GATE2 | Channel 2 Gate-Drive Output. Connect to gate of external N-channel MOSFET. |
| 23 | 21 | SENSE2 | Channel 2 Current-Sense Input. Connect SENSE2 to the drain of an external MOSFET and to one end of RSENSE2. |
| 24 | 22 | IN2 | Channel 2 Supply Input. Connect to a supply voltage from 1V to 13.2V and to one end of RSENSE2. |
| 25 | — | LIM2 | Channel 2 Current-Limit Setting. Connect a resistor from LIM2 to GND to set the current-trip level. Connect to GND for the default 25mV threshold. Do not leave open. |
| 26 | 23 | ON4 | On/Off Channel 4 Control Input (see the <i>Mode</i> section) |
| 27 | 24 | ON3 | On/Off Channel 3 Control Input (see the <i>Mode</i> section) |
| 28 | 1 | MODE | Mode Configuration Input. Mode is configured according to Table 1 as soon as one of the IN_ voltages exceeds UVLO and before turning on OUT_ (see the <i>Mode</i> section). |
| 29 | — | POL | STAT Output Polarity Select (See Table 3 and the <i>Status Output Section</i>) |
| 30 | 2 | ON2 | On/Off Channel 2 Control Input (See the <i>Mode Section</i>) |
| 31 | 3 | ON1 | On/Off Channel 1 Control Input (See the <i>Mode Section</i>) |
| 32 | — | LIM1 | Channel 1 Current-Limit Setting. Connect a resistor from LIM1 to GND to set the current-trip level. Connect to GND for the default 25mV threshold. Do not leave open. |
| EP | — | EP | Exposed Pad. Leave EP floating or connect to GND. |

Detailed Description

The MAX5927/MAX5929 are circuit-breaker ICs for hot-swap applications where a line card is inserted into a live backplane. The MAX5927/MAX5929 operate down to 1V provided one of the inputs is above 2.7V. Normally, when a line card is plugged in to a live backplane, the card's discharged filter capacitors provide low impedance that can momentarily cause the main power supply to collapse. The MAX5927/MAX5929 reside either on the backplane or on the removable card to provide inrush current limiting and short-circuit protection. This is achieved by using external N-channel MOSFETs, external current-sense resistors, and on-chip comparators. The startup period and current-limit threshold of the MAX5927/MAX5929 can be adjusted with external resistors. Figure 1 shows the MAX5927/MAX5929 functional diagram.

The MAX5927 offers four programmable current limits, selectable fault management mode, and selectable STAT_ output polarity. The MAX5929 features fixed current limits, and a variety of fault management and STAT_ polarity option combinations.

Mode

The MAX5927/MAX5929 supports three modes of operation: voltage-tracking, power-sequencing, and independent mode. Select the appropriate mode according to Table 1.

Voltage-Tracking Mode

Connect MODE high to enter voltage-tracking mode. While in voltage-tracking mode, all channels turn on and off together. To turn all channels on:

- At least one $V_{IN_}$ must exceed V_{UVLO} (2.45V) for the UVLO to startup delay (37.5ms).
- All $V_{IN_}$ must exceed V_{PWRRDY} (0.95V).
- All $V_{ON_}$ must exceed $V_{ON,TH}$ (0.875V).
- No faults may be present on any channel.

Table 1. Operational Mode Selection

| MODE | OPERATION |
|------------------------|------------------|
| High (Connect to BIAS) | Voltage tracking |
| OPEN | Power sequencing |
| GND | Independent |

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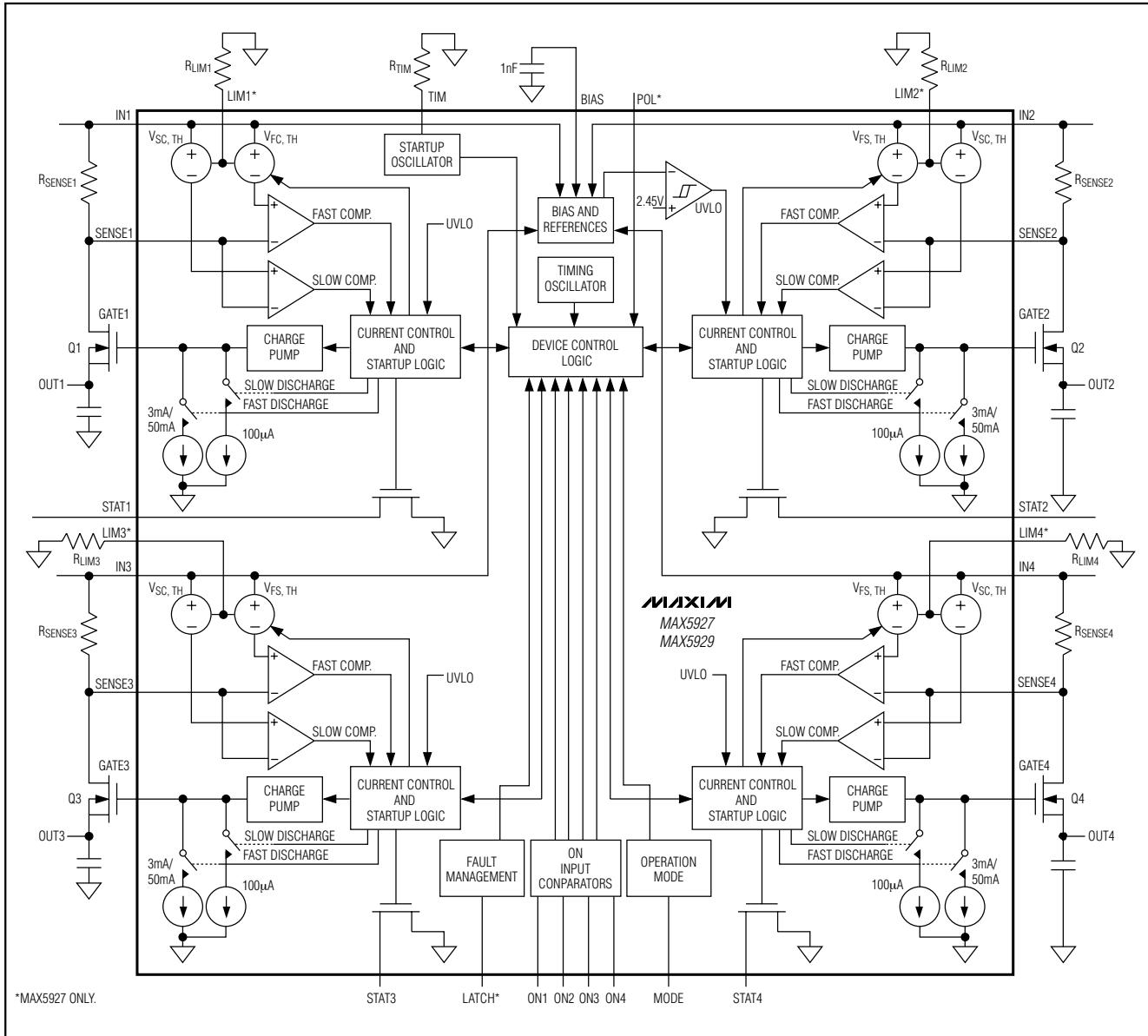


Figure 1. Functional Diagram

The MAX5927/MAX5929 turn off all channels if any of the above conditions are not met. After a fault-latched shutdown, cycle any of the ON_{_} inputs to unlatch and restart all channels.

Power-Sequencing Mode

Leave MODE floating to enter power-sequencing mode. While in power-sequencing mode, the MAX5927/MAX5929 turn on and off each channel

depending on the state of the corresponding V_{ON}_{_}. To turn on a given channel:

- At least one V_{IN}_{_} must exceed V_{UVLO} (2.45V) for the UVLO to startup delay (37.5ms).
- All V_{IN}_{_} must exceed V_{PWRRDY} (0.95V).
- The corresponding V_{ON}_{_} must exceed V_{ON,TH} (0.875V).
- No faults may be present on any channel.

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

MAX5927/MAX5929

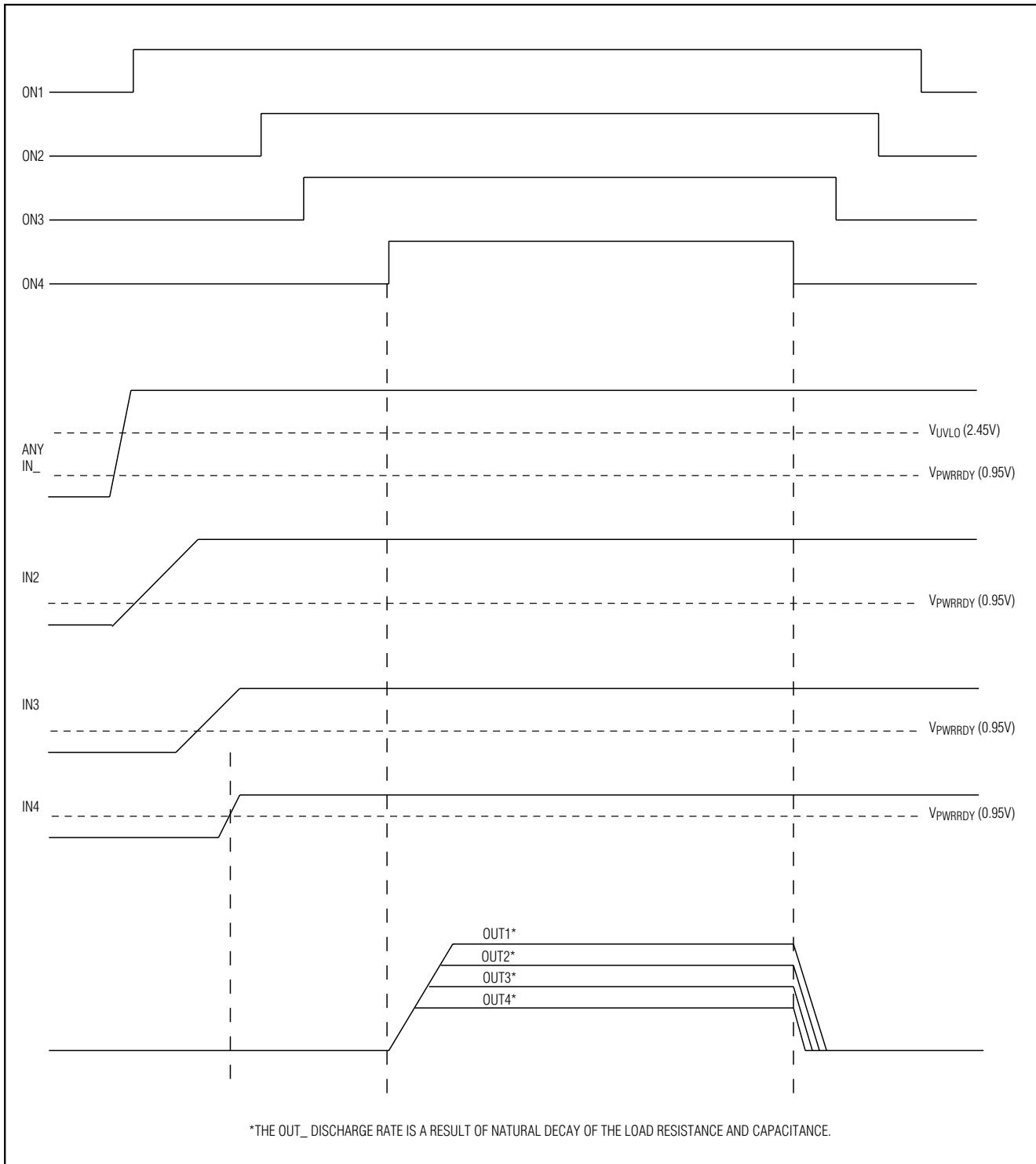


Figure 2. Voltage-Tracking Timing Diagram (Provided t_D , $uvlo$ Requirement is Met)

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

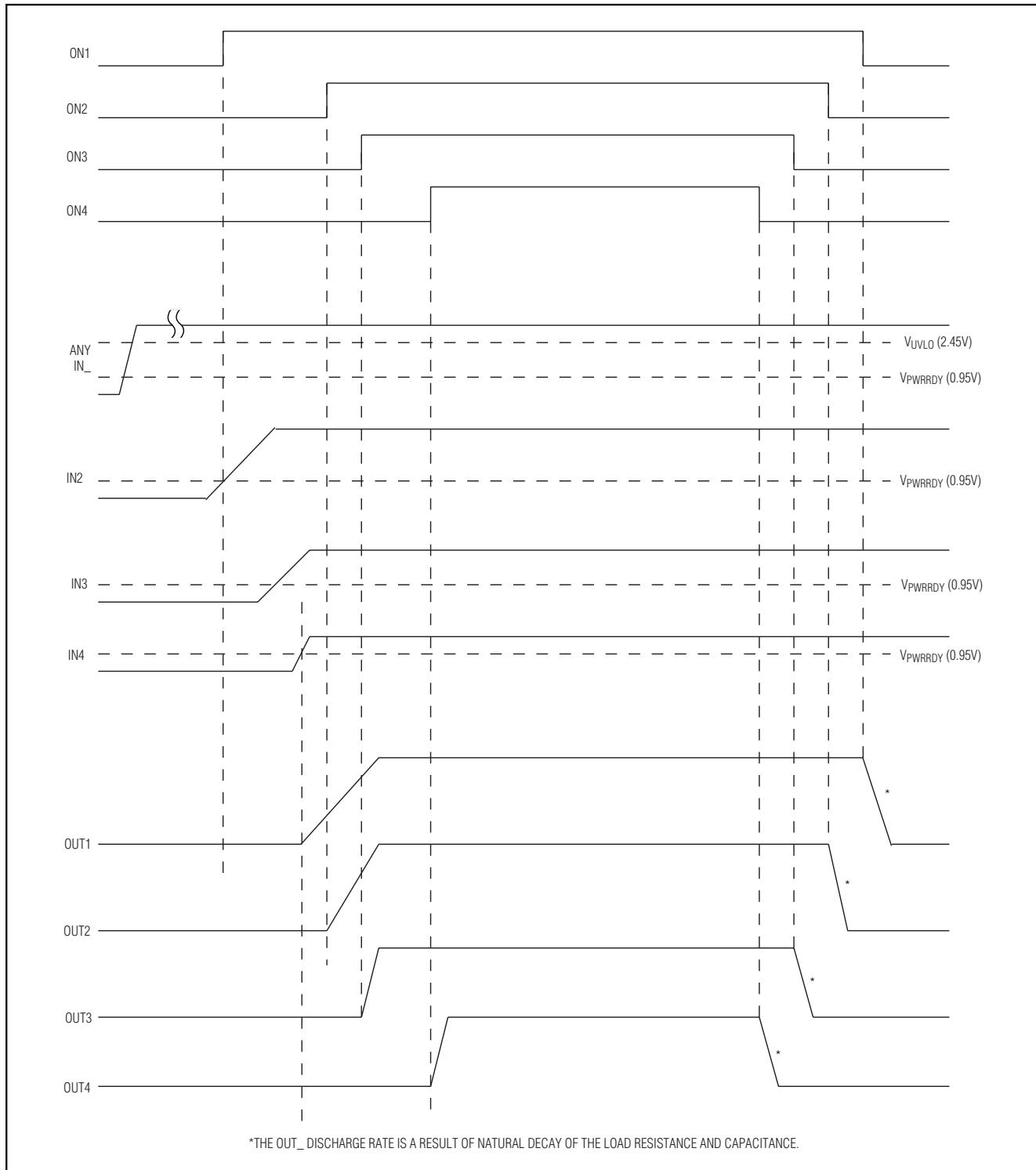


Figure 3. Power-Sequencing Timing Diagram (Provided t_D , UVLO Requirement is Met)

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

MAX5927/MAX5929

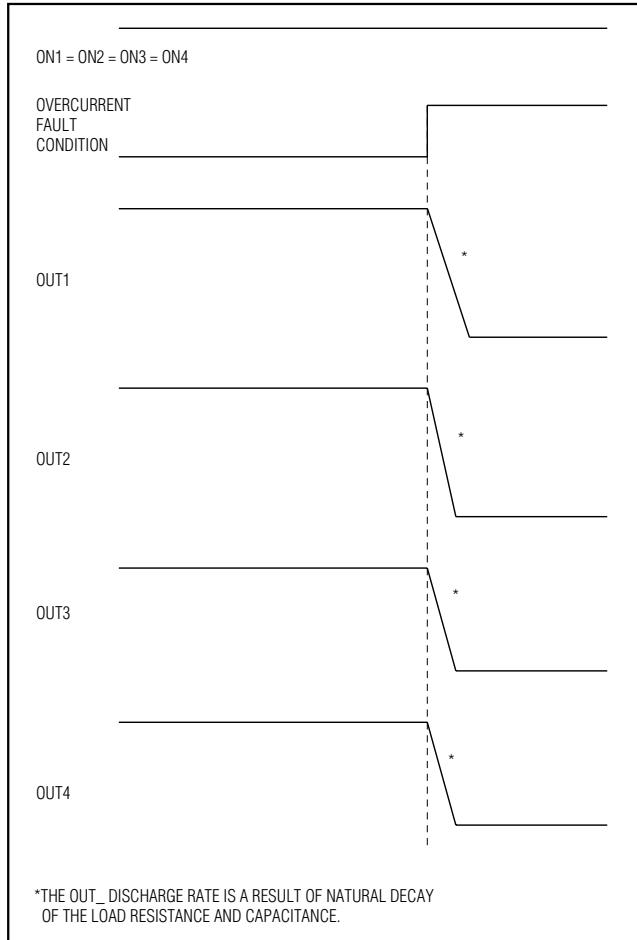


Figure 4. Power-Sequencing Fault Turn-Off

The MAX5927/MAX5929 turn off all channels if any of the above conditions are not met. After a fault-latched shutdown, cycle any of the ON_{_} inputs to unlatch and restart all channels, depending on the corresponding V_{ON} state.

Independent Mode

Connect MODE to GND to enter independent mode. While in independent mode, the MAX5927/MAX5929 provide complete independent control for each channel. To turn on a given channel:

- At least one V_{IN}_{_} must exceed V_{UVLO} (2.45V) for the UVLO to startup delay (37.5ms)
- The corresponding V_{IN}_{_} must exceed V_{PWRRDY} (0.95V)
- The corresponding V_{ON}_{_} must exceed V_{ON,TH} (0.875V)

The MAX5927/MAX5929 turn off the corresponding channel if any of the above conditions are not met. During a fault condition on a given channel only, the affected channel is disabled. After a fault-latched shutdown, recycle the corresponding ON_{_} inputs to unlatch and restart only the corresponding channel.

Startup Period

R_{TIM} sets the duration of the startup period from 0.4ms (R_{TIM} = 4k Ω) to 50ms (R_{TIM} = 500k Ω) (see the *Setting the Startup Period, R_{TIM}* section). The default startup period is fixed at 9ms when TIM is floating. The startup period begins after the turn-on conditions are met as described in the *Mode* section, and the device is not latched or in its autoretry delay (see the *Latched and Autoretry Fault Management* section).

The MAX5927/MAX5929 limit the load current if an overcurrent fault occurs during startup instead of completely turning off the external MOSFETs. The slow comparator is disabled during the startup period and the load current can be limited in two ways:

- 1) Slowly enhancing the MOSFETs by limiting the MOSFET gate-charging current.
- 2) Limiting the voltage across the external current-sense resistor.

During the startup period, the gate-drive current is limited to 100 μ A and decreases with the increase of the gate voltage (see the *Typical Operating Characteristics*). This allows the controller to slowly enhance the MOSFETs. If the fast comparator detects an overcurrent, the MAX5927/MAX5929 regulate the gate voltage to ensure that the voltage across the sense resistor does not exceed V_{SU,TH}. This effectively regulates the inrush current during startup.

Figure 6 shows the startup waveforms. STAT_{_} is asserted immediately after the startup period if no fault condition is present.

VariableSpeed/BiLevel Fault Protection

VariableSpeed/BiLevel fault protection incorporates comparators with different thresholds and response times to monitor the load current (Figure 7). During the startup period, protection is provided by limiting the load current. Protection is provided in normal operation (after the startup period has expired) by discharging the MOSFET gates with a 3mA/50mA pulldown current in response to a fault condition. After a fault, STAT_{_} is deasserted, the MAX5929L stays latched off and the MAX5929A automatically restart. Use the MAX5927 LATCH input to control whether the STAT_{_} outputs latch off or Autoretry after a fault condition (see the *Latched and Autoretry Fault Management* section).

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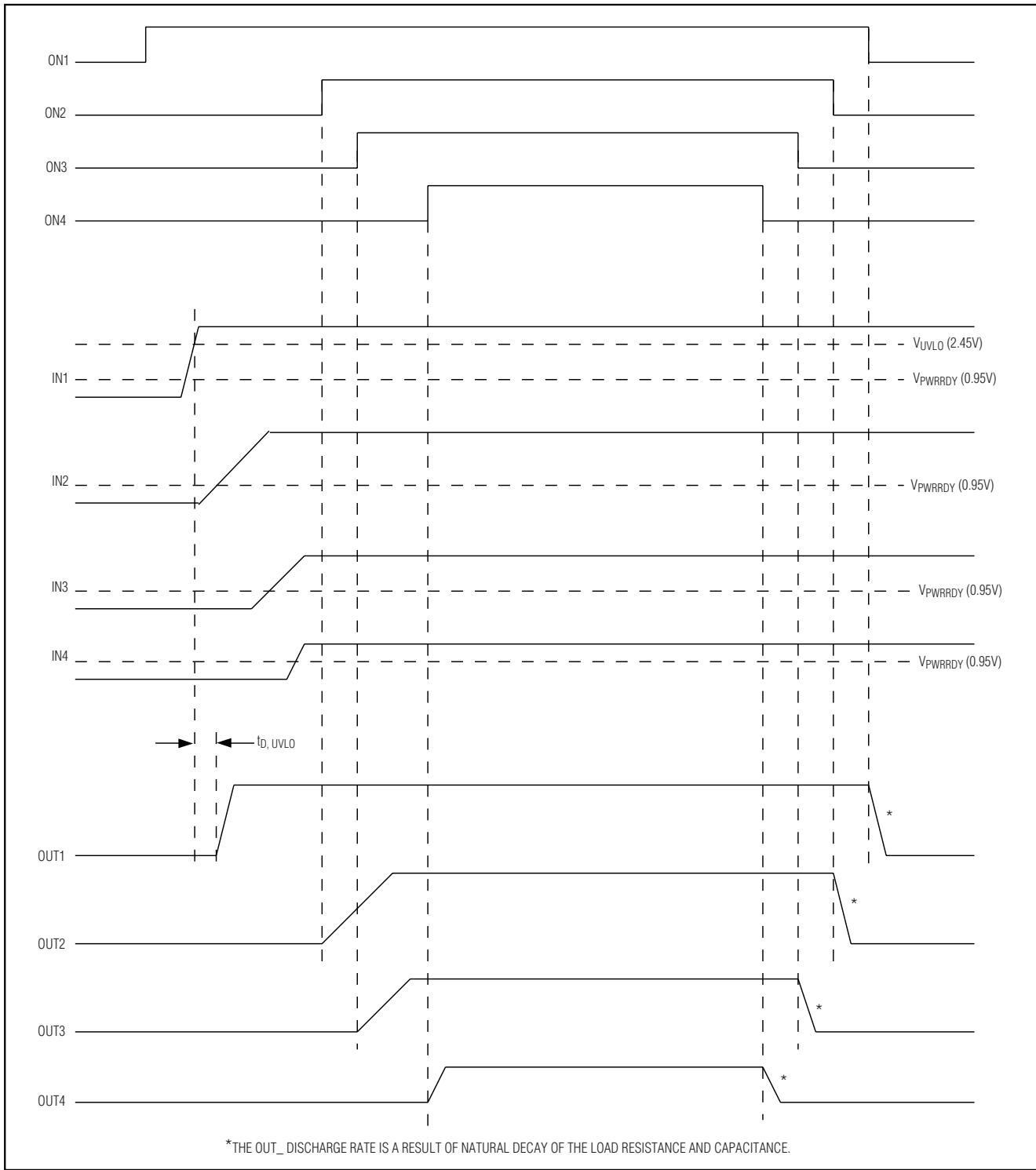


Figure 5. Independent Mode Timing Diagram

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

MAX5927/MAX5929

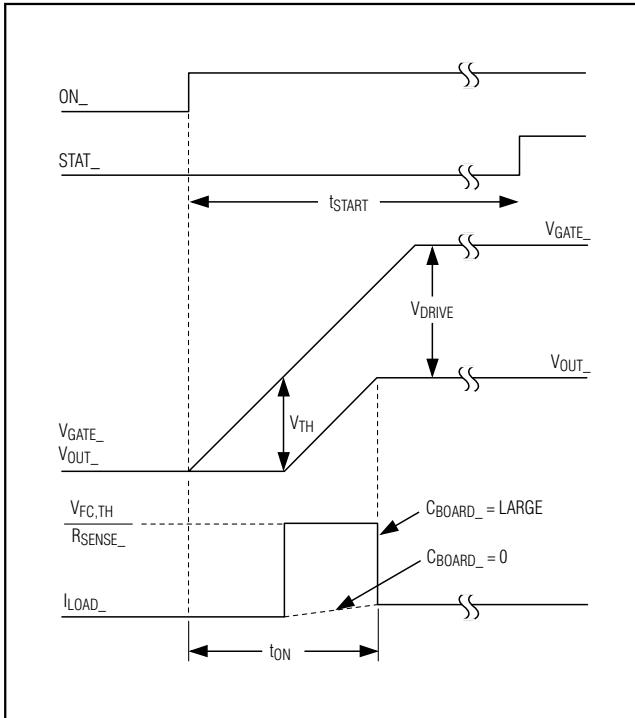


Figure 6. Independent Mode Startup Waveforms

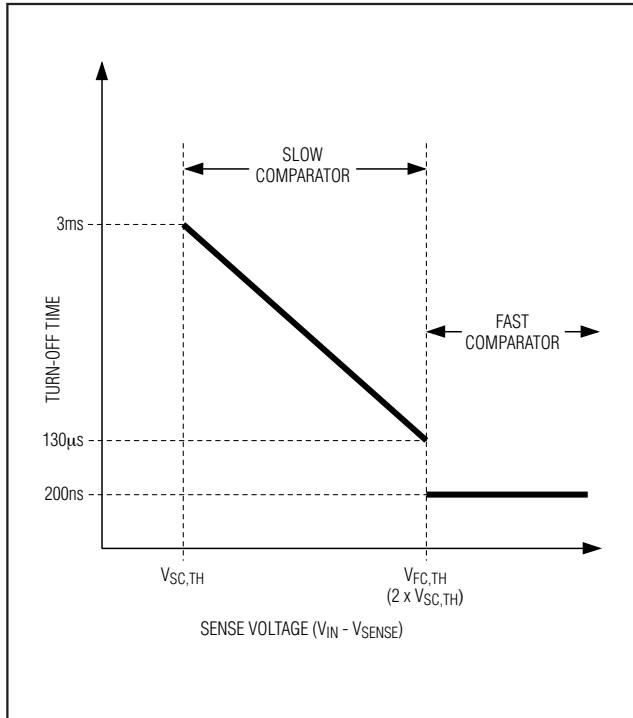


Figure 7. VariableSpeed/BiLevel Response

Slow-Comparator Startup Period

The slow comparator is disabled during the startup period while the external MOSFETs are turning on. Disabling the slow comparator allows the device to ignore the higher-than-normal inrush current charging the board capacitors when a card is first plugged into a live backplane.

Slow-Comparator Normal Operation

After the startup period is complete, the slow comparator is enabled and the device enters normal operation. The comparator threshold voltage ($V_{SC,TH}$) is adjustable from 25mV to 100mV. The slow-comparator response time is 3ms for a 1mV overdrive. The response time decreases to 100μs with a large overdrive. The variable-speed response time allows the MAX5927/MAX5929 to ignore low-amplitude momentary glitches, thus increasing system noise immunity. After an extended overcurrent condition, a fault is generated, STAT_ outputs are deasserted, and the MOSFET gates are discharged with a 3mA pulldown current.

Fast-Comparator Startup Period

During the startup period, the fast comparator regulates the gate voltages to ensure that the voltage

across the sense resistor does not exceed the startup fast-comparator threshold voltage ($V_{SU,TH}$), $V_{SU,TH}$ is scaled to two times the slow-comparator threshold ($V_{SC,TH}$).

Fast-Comparator Normal Operation

In normal operation, if the load current reaches the fast-comparator threshold, a fault is generated, STAT_ is deasserted, and the MOSFET gates are discharged with a strong 50mA pulldown current. This happens in the event of a serious current overload or a dead short. The fast-comparator threshold voltage ($V_{FC,TH}$) is scaled to two times the slow-comparator threshold ($V_{SC,TH}$). This comparator has a fast response time of 200ns (Figure 7).

Undervoltage Lockout (UVLO)

The UVLO prevents the MAX5927/MAX5929 from turning on the external MOSFETs until one input voltage exceeds the UVLO threshold (2.45V) for $t_{D,UVLO}$. The MAX5927/MAX5929 use power from the highest input voltage rail for the charge pumps. This allows for more efficient charge-pump operation. The highest V_{IN} is provided as an output at BIAS. The UVLO protects the external MOSFETs from an insufficient gate-drive volt-

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Table 2. Selecting Fault Management Mode (MAX5927)

| LATCH | FAULT MANAGEMENT |
|----------|-------------------------------------|
| Floating | Fault condition latches MOSFETs off |
| Low | Autoretry mode |

Table 3. Selecting STAT_ Polarity (MAX5927)

| POL | STAT_ |
|----------|---------------------------|
| Low | Asserts low |
| Floating | Asserts high (open drain) |

age. $t_{D,UVLO}$ ensures that the board is fully inserted into the backplane and that the input voltages are stable. The MAX5927/MAX5929 include a UVLO glitch filter, $t_{D,GF}$, to reject all input voltage noise and transients. Bringing all input supplies below the UVLO threshold for longer than $t_{D,GF}$ reinitiates $t_{D,UVLO}$ and the startup period, t_{START} . See Figure 8 for an example of automatic turn-on function.

Latched and Autoretry Fault Management

The MAX5929L always latch the external MOSFETs off when an overcurrent fault is detected, and the MAX5929A are always in autoretry mode. The MAX5927 can be configured to either latch the external MOSFETs off or to autoretry (see Table 2). Toggling $ON_{_}$ below 0.875V for at least 100 μ s clears the MAX5929L or MAX5927 (LATCH = FLOAT) fault and reinitiates the startup period. Similarly, the MAX5929A or MAX5927 (LATCH = GND) turn the external MOSFETs off when an overcurrent fault is detected, then automatically restart after the autoretry delay that is internally set to 64 times t_{START} .

Status Outputs (STAT_)

The status (STAT_) outputs are open-drain outputs that assert when hot swap is successful and t_{START} has elapsed. STAT_ deasserts if $ON_{_}$ is low or if the channel is turned off for any fault condition.

The polarity of the STAT_ outputs is selected using POL for the MAX5927 (see Table 3). Tables 4 and 5 contain the MAX5927/MAX5929 truth tables.

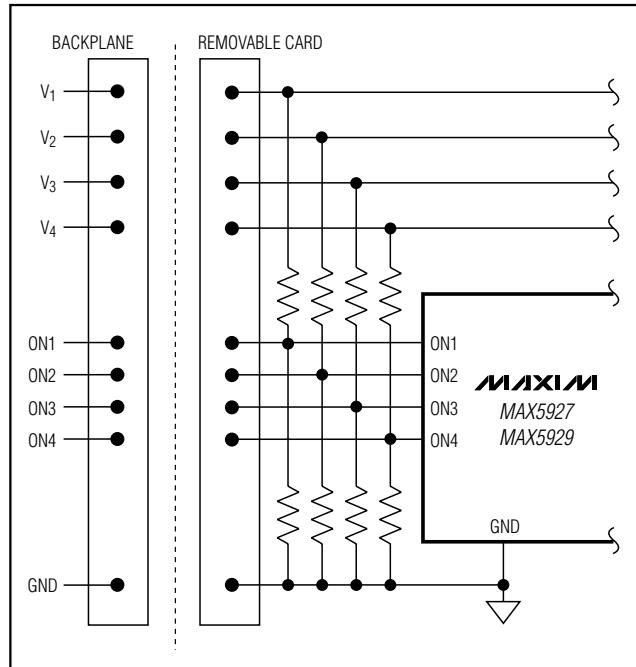


Figure 8. Automatic Turn-On when Input Voltages are Above their Respective Undervoltage Lockout Threshold (Provided $t_{D,UVLO}$ Requirement is Met)

Applications Information

Component Selection

N-Channel MOSFETs

Select the external MOSFETs according to the application's current levels. Table 6 lists recommended components. The MOSFET's on-resistance ($R_{DS(ON)}$) should be chosen low enough to have a minimum voltage drop at full load to limit the MOSFET power dissipation. High $R_{DS(ON)}$ causes output ripple if there is a pulsating load. Determine the device power rating to accommodate a short-circuit condition on the board at startup and when the device is in autoretry mode (see the *MOSFET Thermal Considerations* section).

Using these devices in latched mode allows the use of MOSFETs with lower power ratings. A MOSFET typically withstands single-shot pulses with higher dissipation than the specified package rating. Table 7 lists some recommended MOSFET manufacturers.

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Table 4. Status Output Truth Table: Voltage-Tracking and Power-Sequencing Modes

| PART | CHANNEL 1 FAULT | CHANNEL 2 FAULT | CHANNEL 3 FAULT | CHANNEL 4 FAULT | STAT1/GATE1* | STAT2/GATE2* | STAT3/GATE3* | STAT4/GATE4* |
|---------------------------------|-----------------|-----------------|-----------------|-----------------|--------------|--------------|--------------|--------------|
| MAX5927 (POL = 1), MAX5929_H | Yes | X | X | X | L/OFF | L/OFF | L/OFF | L/OFF |
| | X | Yes | X | X | L/OFF | L/OFF | L/OFF | L/OFF |
| | X | X | Yes | X | L/OFF | L/OFF | L/OFF | L/OFF |
| | X | X | X | Yes | L/OFF | L/OFF | L/OFF | L/OFF |
| | No | No | No | No | H/ON | H/ON | H/ON | H/ON |
| MAX5927 (POL = 0), MAX5929_L | Yes | X | X | X | H/OFF | H/OFF | H/OFF | H/OFF |
| | X | Yes | X | X | H/OFF | H/OFF | H/OFF | H/OFF |
| | X | X | Yes | X | H/OFF | H/OFF | H/OFF | H/OFF |
| | X | X | X | Yes | H/OFF | H/OFF | H/OFF | H/OFF |
| | No | No | No | No | L/ON | L/ON | L/ON | L/ON |

*L = Low, H = High.

Table 5. Status Output Truth Table: Independent Mode

| CHANNEL 1 FAULT | CHANNEL 2 FAULT | CHANNEL 3 FAULT | CHANNEL 4 FAULT | STAT1/GATE1 | STAT2/GATE2 | STAT3/GATE3 | STAT4/GATE4 |
|-----------------|-----------------|-----------------|-----------------|----------------|----------------|----------------|----------------|
| Yes | Yes | Yes | Yes | Unasserted/OFF | Unasserted/OFF | Unasserted/OFF | Unasserted/OFF |
| Yes | Yes | Yes | No | Unasserted/OFF | Unasserted/OFF | Unasserted/OFF | Asserted/ON |
| Yes | Yes | No | Yes | Unasserted/OFF | Unasserted/OFF | Asserted/ON | Unasserted/OFF |
| Yes | Yes | No | No | Unasserted/OFF | Unasserted/OFF | Asserted/ON | Asserted/ON |
| Yes | No | Yes | Yes | Unasserted/OFF | Asserted/ON | Unasserted/OFF | Unasserted/OFF |
| Yes | No | Yes | No | Unasserted/OFF | Asserted/ON | Unasserted/OFF | Asserted/ON |
| Yes | No | No | Yes | Unasserted/OFF | Asserted/ON | Asserted/ON | Unasserted/OFF |
| Yes | No | No | No | Unasserted/OFF | Asserted/ON | Asserted/ON | Asserted/ON |
| No | Yes | Yes | Yes | Asserted/ON | Unasserted/OFF | Unasserted/OFF | Unasserted/OFF |
| No | Yes | Yes | No | Asserted/ON | Unasserted/OFF | Unasserted/OFF | Asserted/ON |
| No | Yes | No | Yes | Asserted/ON | Unasserted/OFF | Asserted/ON | Unasserted/OFF |
| No | Yes | No | No | Asserted/ON | Unasserted/OFF | Asserted/ON | Asserted/ON |
| No | No | Yes | Yes | Asserted/ON | Asserted/ON | Unasserted/OFF | Unasserted/OFF |
| No | No | Yes | No | Asserted/ON | Asserted/ON | Unasserted/OFF | Asserted/ON |
| No | No | No | Yes | Asserted/ON | Asserted/ON | Asserted/ON | Unasserted/OFF |
| No | No | No | No | Asserted/ON | Asserted/ON | Asserted/ON | Asserted/ON |

(Note: STAT_ is asserted when hot swap is successful and t_{ON} has elapsed. STAT_ is unasserted during a fault)

MAX5927/MAX5929

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Table 6. Recommended N-Channel MOSFETs

| PART NUMBER | MANUFACTURER | DESCRIPTION |
|-------------|-------------------------|--------------------------------|
| IRF7413 | International Rectifier | 11mΩ, 8-pin SO, 30V |
| IRF7401 | | 22mΩ, 8-pin SO, 20V |
| IRL3502S | | 6mΩ, D ² PAK, 20V |
| MMSF3300 | Motorola | 20mΩ, 8-pin SO, 30V |
| MMSF5N02H | | 30mΩ, 8-pin SO, 20V |
| MTB60N05H | | 14mΩ, D ² PAK, 50V |
| FDS6670A | | 10mΩ, 8-pin SO, 30V |
| ND8426A | Fairchild | 13.5mΩ, 8-pin SO, 20V |
| FDB8030L | | 4.5mΩ, D ² PAK, 30V |

Table 7. Component Manufacturers

| COMPONENT | MANUFACTURER | PHONE | WEBSITE |
|-----------------|-------------------------|--------------|--|
| Sense Resistors | Dale-Vishay | 402-562-3131 | www.vishay.com |
| | IRC | 704-264-8861 | www.irctt.com |
| MOSFETs | International Rectifier | 310-233-3331 | www.irf.com |
| | Fairchild | 888-522-5372 | www.fairchildsemi.com |
| | Motorola | 602-224-3576 | www.mot-sps.com/ppd |

Sense Resistor

The slow-comparator threshold voltage is adjustable from 25mV to 100mV. Select a sense resistor that causes a drop equal to the slow-comparator threshold voltage at a current level above the maximum normal operating current. Typically, set the overload current at 1.2 to 1.5 times the full load current. The fast-comparator threshold is two times the slow-comparator threshold in normal operating mode. Choose the sense resistor power rating to be greater than or equal to $2 \times (\text{!OVERLOAD}) \times V_{SC,TH}$. Table 7 lists some recommended sense resistor manufacturers.

Slow-Comparator Threshold, R_{LIM} (MAX5927)

The slow-comparator threshold voltage is adjustable from 25mV to 100mV, allowing designers to fine-tune the current-limit threshold for use with standard-value sense resistors. Low slow-comparator thresholds allow for increased efficiency by reducing the power dissipated by the sense resistor. Furthermore, the low 25mV slow-comparator threshold is beneficial when operating with supply rails down to 1V because it allows a small percentage of the overall output voltage to be used for current sensing. The VariableSpeed/BiLevel fault protection feature offers inherent system immunity against load transients and noise. This allows the slow-comparator threshold to be set close to the maximum nor-

mal operating level without experiencing nuisance faults. To adjust the slow-comparator threshold, calculate R_{LIM} as follows:

$$R_{LIM} = \frac{V_{TH} - 25mV}{7.5\mu A}$$

where V_{TH} is the desired slow-comparator threshold voltage. Shorting LIM_- to GND sets V_{TH} to 25mV. **Do not leave LIM_- open.**

Setting the Startup Period, R_{TIM}

The startup period (t_{START}) is adjustable from 0.4ms to 50ms. The adjustable startup period feature allows systems to be customized for MOSFET gate capacitance and board capacitance (C_{BOARD}). The startup period is adjusted with a resistor connected from TIM to GND (R_{TIM}). R_{TIM} must be between 4kΩ and 500kΩ. The startup period has a default value of 9ms when TIM is left floating. Calculate R_{TIM} with the following equation:

$$R_{TIM} = \frac{t_{START}}{128 \times 800pF}$$

where t_{START} is the desired startup period.

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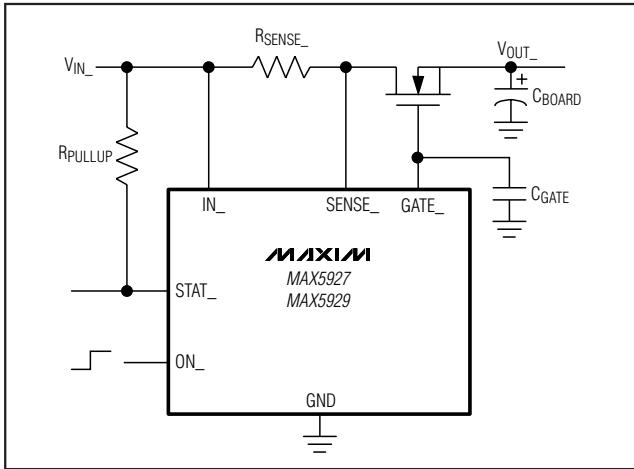


Figure 9. Operating with an External Gate Capacitor

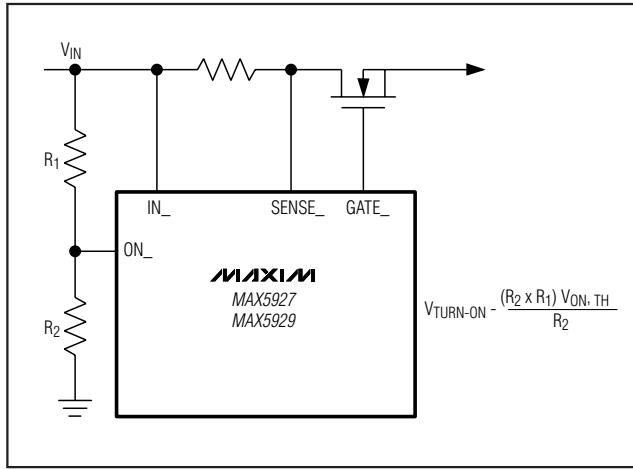


Figure 10. Adjustable Undervoltage Lockout

Startup Sequence

There are two ways of completing the startup sequence. **Case A** describes a startup sequence that slowly turns on the MOSFETs by limiting the gate charge. **Case B** uses the current-limiting feature and turns on the MOSFETs as fast as possible while still preventing a high inrush current. The output voltage ramp-up time (t_{ON}) is determined by the longer of the two timings, case A and case B. Set the startup timer (t_{START}) to be longer than t_{ON} to guarantee enough time for the output voltage to settle.

Case A: Slow Turn-On (Without Current Limit)

There are two ways to turn on the MOSFETs without reaching the fast-comparator current limit:

- If the board capacitance (C_{BOARD}) is small, the inrush current is low.
- If the gate capacitance is high, the MOSFETs turn on slowly.

In both cases, the turn-on time is determined only by the charge required to enhance the MOSFET. The small 100 μ A gate-charging current effectively limits the output voltage dV/dt . Connecting an external capacitor between GATE and GND extends the turn-on time. The time required to charge/discharge a MOSFET is as follows:

$$t = \frac{C_{GATE} \times \Delta V_{GATE} + Q_{GATE}}{I_{GATE}}$$

where:

C_{GATE} is the external gate to ground capacitance (Figure 9),

ΔV_{GATE} is the change in gate charge,

Q_{GATE} is the MOSFET total gate charge,

I_{GATE} is the gate-charging/discharging current.

In this case, the inrush current depends on the MOSFET gate-to-drain capacitance (C_{rss}) plus any additional capacitance from GATE to GND (C_{GATE}), and on any load current (I_{LOAD}) present during the startup period.

$$I_{INRUSH} = \frac{C_{BOARD}}{C_{rss} + C_{GATE}} \times I_{GATE} + I_{LOAD}$$

Example: Charging and discharging times using the Fairchild FDB7030L MOSFET

If $V_{IN1} = 5V$ then GATE1 charges up to 10.4V ($V_{IN1} + V_{DRIVE}$), therefore $\Delta V_{GATE} = 10.4V$. The manufacturer's data sheet specifies that the FDB7030L has approximately 60nC of gate charge and $C_{rss} = 600pF$. The MAX5927/MAX5929 have a 100 μ A gate-charging current and a 3mA/50mA normal/strong discharging current. $C_{BOARD} = 6\mu F$ and the load does not draw any current during the startup period. With no gate capacitor, the inrush current, charge, and discharge times are:

$$I_{INRUSH} = \frac{6\mu F}{600pF + 0} \times 100\mu A + 0 = 1A$$

$$I_{CHARGE} = \frac{0 \times 10.4V + 60nC}{100\mu A} = 0.6ms$$

$$t_{DISCHARGE} = \frac{0 \times 10.4V + 60nC}{3mA} = 0.02ms$$

$$t_{DISCHARGE(STRONG)} = \frac{0 \times 10.4V + 60nC}{50mA} = 1.2\mu s$$

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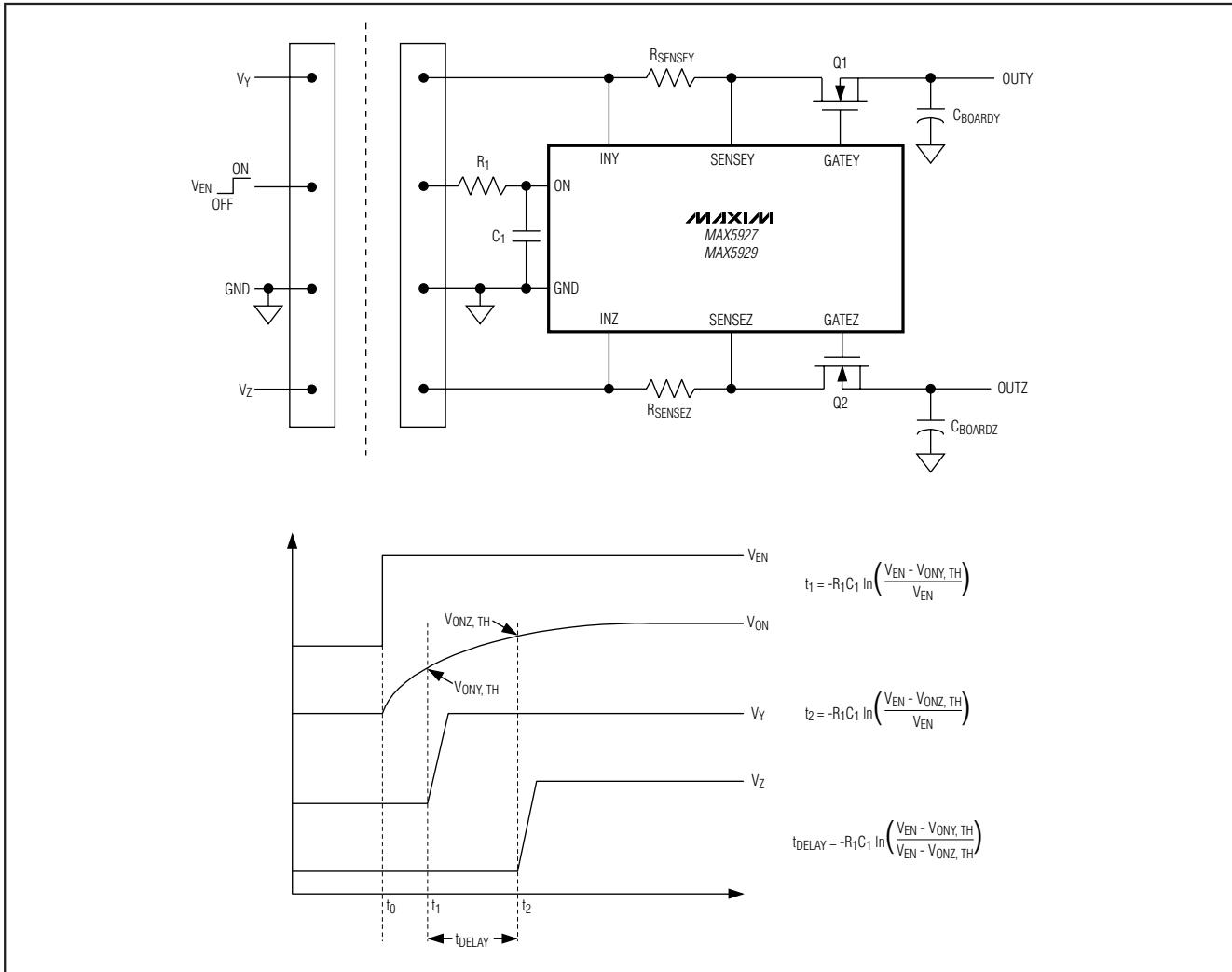


Figure 11. Power Sequencing: Channel Z Turns On t_{DELAY} After Channel Y

With a 22nF gate capacitor, the inrush current, charge, and discharge times are:

$$I_{INRUSH} = \frac{6\mu F}{600pF + 22nF} \times 100\mu A + 0 = 26.5mA$$

$$t_{CHARGE} = \frac{22nF \times 10.4V + 60nC}{100\mu A} = 2.89ms$$

$$t_{DISCHARGE} = \frac{22nF \times 10.4V + 60nC}{3mA} = 0.096ms$$

$$t_{DISCHARGE(STRONG)} = \frac{22nF \times 10.4V + 60nC}{50mA} = 5.8\mu s$$

Case B: Fast Turn-On (With Current Limit)

In applications where the board capacitance (C_{BOARD}) is high, the inrush current causes a voltage drop across R_{SENSE} that exceeds the startup fast-comparator threshold. The fast comparator regulates the voltage across the sense resistor to $V_{FC,TH}$. This effectively regulates the inrush current during startup. In this case, the current charging C_{BOARD} can be considered constant and the turn-on time is:

$$t_{ON} = \frac{C_{BOARD} \times V_{IN} \times R_{SENSE}}{V_{FC,TH}}$$

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The maximum inrush current in this case is:

$$I_{\text{INRUSH}} = \frac{V_{\text{FC,TH}}}{R_{\text{SENSE}}}$$

Figure 6 shows the waveforms and timing diagrams for a startup transient with current regulation (see the *Typical Operating Characteristics*). **When operating under this condition, an external gate capacitor is not required.**

ON Comparators

The ON comparators control the on/off function of the MAX5927/MAX5929. ON_ is also used to reset the fault latch (latch mode). Pull V_{ON_} low for 100μs, TUNLATCH, to reset the shutdown latch. ON_ also programs the UVLO threshold (see Figure 10). A resistive-divider between V_{IN_}, V_{ON_}, and GND sets the user programmable turn-on voltage. In power-sequencing mode, an RC circuit can be used at ON_ to set the delay timing (see Figure 11).

Using the MAX5927/MAX5929 on the Backplane

Using the MAX5927/MAX5929 on the backplane allows multiple cards with different input capacitance to be inserted into the same slot even if the card does not have on-board hot-swap protection. The startup period can be triggered if IN_ is connected to ON_ through a trace on the card (Figure 12).

Input Transients

The voltage at IN1, IN2, IN3, or IN4 must be above V_{UVLO} during inrush and fault conditions. When a short-circuit condition occurs on the board, the fast comparator trips cause the external MOSFET gates to be discharged at 50mA according to the mode of operation (see the *Mode* section). The main system power supply must be able to sustain a temporary fault current, without dropping below the UVLO threshold of 2.45V, until the external MOSFET is completely off. If the main system power supply collapses below UVLO, the MAX5927/MAX5929 force the device to restart once the supply has recovered. The MOSFET is turned off in a very short time resulting in a high di/dt. The backplane delivering the power to the external card must have low inductance to minimize voltage transients caused by this high di/dt.

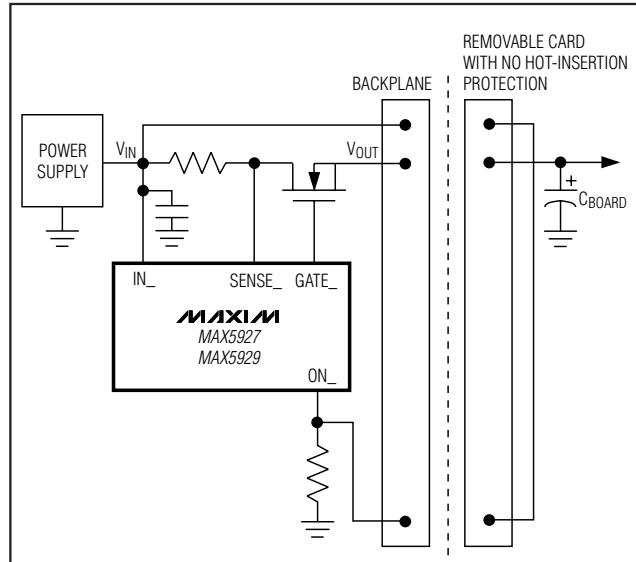


Figure 12. Using the MAX5927/MAX5929 on a Backplane

MOSFET Thermal Considerations

During normal operation, the external MOSFETs dissipate little power. The MOSFET R_{DSON} is low when the MOSFET is fully enhanced. The power dissipated in normal operation is P_D = I_{LOAD}² × R_{DSON}. The most power dissipation occurs during the turn-on and turn-off transients when the MOSFETs are in their linear regions. Take into consideration the worst-case scenario of a continuous short-circuit fault, consider these two cases:

- 1) The single turn-on with the device latched after a fault: MAX5927 (LATCH = high or floating) or MAX5929L.
- 2) The continuous autoretry after a fault: (MAX5927 (LATCH = low) or MAX5929A.

MOSFET manufacturers typically include the package thermal resistance from junction to ambient (R_{θJA}) and thermal resistance from junction to case (R_{θJC}), which determines the startup time and the retry duty cycle (d = t_{START}/(t_{START} + t_{RETRY})). Calculate the required transient thermal resistance with the following equation:

$$Z_{\theta JA(\text{MAX})} \leq \frac{T_{\text{JMAX}} - T_{\text{A}}}{V_{\text{IN}} \times I_{\text{START}}}$$

where I_{START} = V_{SU,TH}/R_{SENSE}.

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Layout Considerations

To take full tracking advantage of the switch response time to an output fault condition, it is important to keep all traces as short as possible and to maximize the high-current trace dimensions to reduce the effect of undesirable parasitic inductance. Place the MAX5927/MAX5929 close to the card's connector. Use a ground plane to minimize impedance and inductance. Minimize the current-sense resistor trace length (<10mm), and ensure accurate current sensing with Kelvin connections (Figure 13).

When the output is short circuited, the voltage drop across the external MOSFET becomes large. Hence, the power dissipation across the switch increases, as does the die temperature. An efficient way to achieve good power dissipation on a surface-mount package is to lay out two copper pads directly under the MOSFET package on both sides of the board. Connect the two pads to the ground plane through vias, and use enlarged copper mounting pads on the topside of the board.

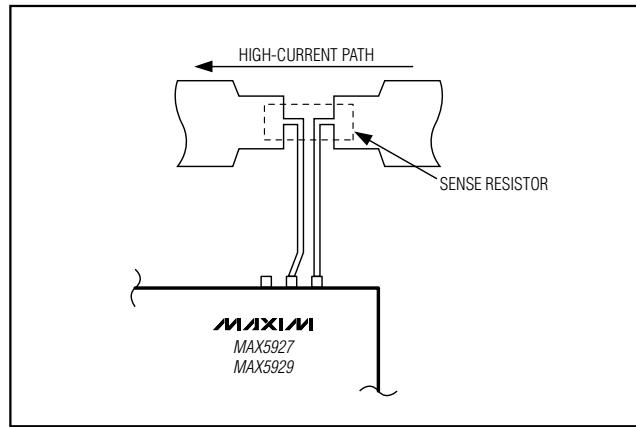
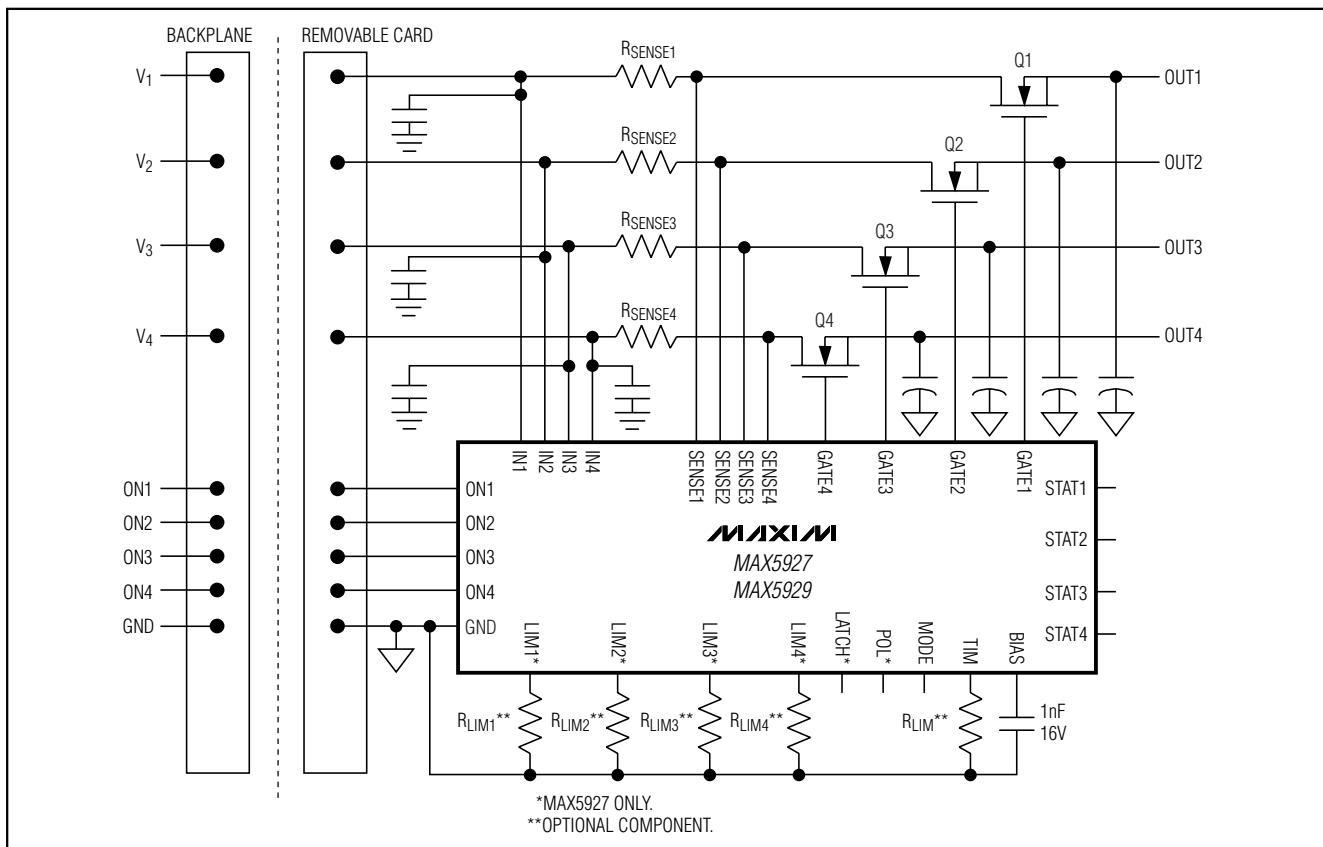


Figure 13. Kelvin Connection for the Current-Sense Resistors

Typical Operating Circuit

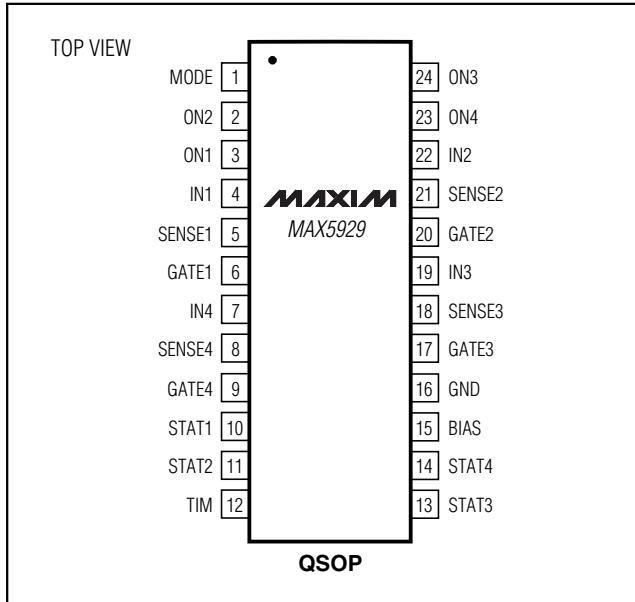


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Selector Guide

| PART | CURRENT LIMIT | FAULT MANAGEMENT | STAT_POLARITY |
|--------------|---------------|------------------|----------------------------|
| MAX5927ETJ | Programmable | Selectable | Selectable |
| MAX5929LHEEG | Fixed | Latched | Asserted high (open drain) |
| MAX5929LLEEG | Fixed | Latched | Asserted low |
| MAX5929AHEEG | Fixed | Autoretry | Asserted high (open drain) |
| MAX5929ALEEG | Fixed | Autoretry | Asserted low |

Pin Configurations (continued)



Chip Information

TRANSISTOR COUNT: 7704

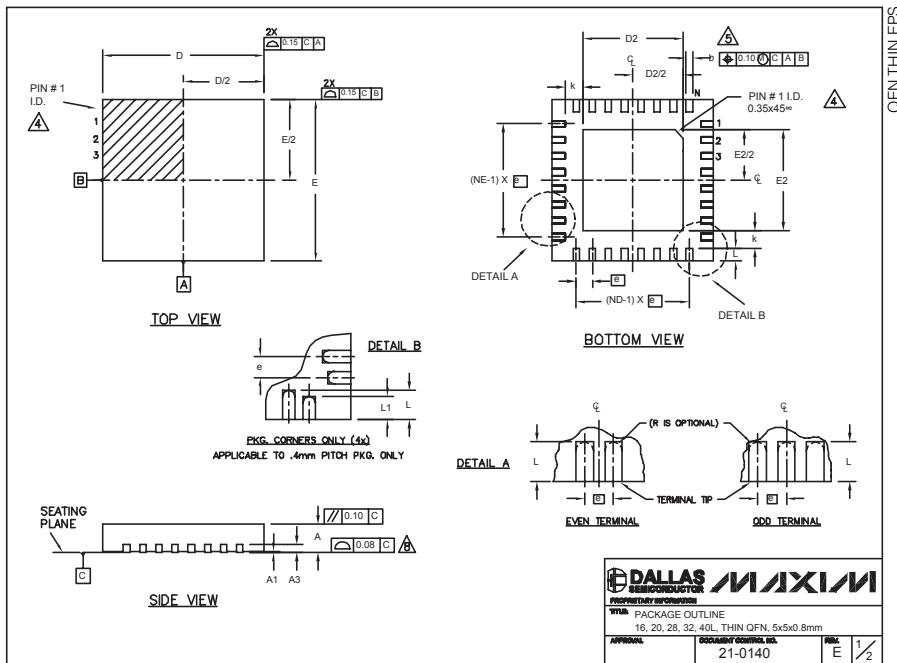
PROCESS: BiCMOS

MAX5927/MAX5929

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



| COMMON DIMENSIONS | | | | | | | | | | |
|-------------------|---------|---------|---------|---------|---------|------|------|------|------|------|
| PKG. | 16L 5x5 | 20L 5x5 | 28L 5x5 | 32L 5x5 | 40L 5x5 | | | | | |
| SYMBOL | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | |
| A | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | |
| A1 | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | |
| A3 | 0.20 | REF. | 0.20 | REF. | 0.20 | REF. | 0.20 | REF. | 0.20 | |
| b | 0.25 | 0.30 | 0.35 | 0.25 | 0.30 | 0.35 | 0.20 | 0.25 | 0.30 | |
| D | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | |
| E | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | |
| e | 0.80 | BSC. | 0.65 | BSC. | 0.50 | BSC. | 0.50 | BSC. | 0.40 | BSC. |
| k | 0.25 | - | - | 0.25 | - | - | 0.25 | - | - | |
| L | 0.30 | 0.40 | 0.50 | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | |
| L1 | - | - | - | - | - | - | - | - | - | |
| N | 16 | 20 | 28 | 32 | 32 | 40 | | | | |
| ND | 4 | 5 | 7 | 8 | 8 | 10 | | | | |
| NE | 4 | 5 | 7 | 8 | 8 | 10 | | | | |
| JEDEC | WHLB | WHLH | WHDH-1 | WHDH-2 | | - | | | | |

NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.

△ THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.

△ DIMENSION *a* APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.

△ ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

△ COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT EXPOSED PAD DIMENSION FOR T2855-1, T2855-3 AND T2855-6.

10. WARPAGE SHALL NOT EXCEED 0.10 mm.

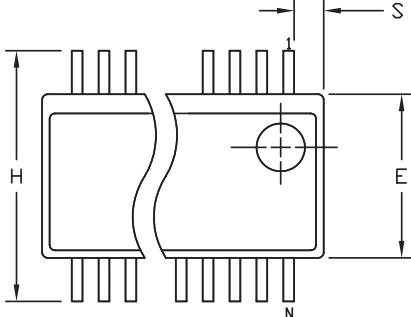
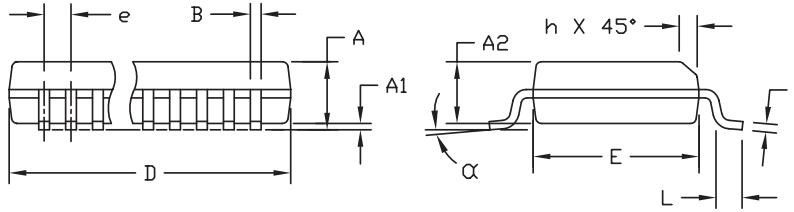
| EXPOSED PAD VARIATIONS | | | | | | | | | |
|------------------------|------|------|------|------|------|------|---------------------------|------|------|
| PKG. CODES | D2 | | | E2 | | | DOWN ANGLES ALLOWED | | |
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| T1655-1 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | NO | | |
| T1655-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | YES | | |
| T2055-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | NO | | |
| T2055-3 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | YES | | |
| T2055-4 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | NO | | |
| T2855-1 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 | NO | | |
| T2855-2 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 | NO | | |
| T2855-3 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 | YES | | |
| T2855-4 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 | YES | | |
| T2855-5 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 | NO | | |
| T2855-6 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.35 | NO | | |
| T2855-7 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.80 | YES | | |
| T3255-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | NO | | |
| T3255-3 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | YES | | |
| T3255-4 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.20 | NO | | |
| T4055-1 | 3.20 | 3.30 | 3.40 | 3.20 | 3.30 | 3.40 | YES | | |

DALLAS SEMICONDUCTOR
PROPRIETARY INFORMATION
T2855 PACKAGE OUTLINE
16, 20, 28, 32, 40L, THIN QFN, 5x5x0.8mm
APPROVAL DOCUMENT CONTROL NO. 21-0140 PAGE E 1/2

Low-Voltage, Quad, Hot-Swap Controllers/Power Sequencers

Package Information (continued)

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MAX5927/MAX5929

QSOP-16

| DIM | INCHES | | MILLIMETERS | |
|----------|----------------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .061 | .068 | 1.55 | 1.73 |
| A1 | .004 | .0098 | 0.102 | 0.249 |
| A2 | .055 | .061 | 1.40 | 1.55 |
| B | .008 | .012 | 0.20 | 0.30 |
| C | .0075 | .0098 | 0.191 | 0.249 |
| D | SEE VARIATIONS | | | |
| E | .150 | .157 | 3.81 | 3.99 |
| e | .025 | BSC | 0.635 | BSC |
| H | .230 | .244 | 5.84 | 6.20 |
| h | .010 | .016 | 0.25 | 0.41 |
| L | .016 | .035 | 0.41 | 0.89 |
| N | SEE VARIATIONS | | | |
| α | 0° | 8° | 0° | 8° |

VARIATIONS:

| DIM | INCHES | | MILLIMETERS | | N |
|-----|--------|-------|-------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| D | .189 | .196 | 4.80 | 4.98 | 16 AB |
| S | .0020 | .0070 | 0.05 | 0.18 | |
| D | .337 | .344 | 8.56 | 8.74 | 20 AD |
| S | .0500 | .0550 | 1.270 | 1.397 | |
| D | .337 | .344 | 8.56 | 8.74 | 24 AE |
| S | .0250 | .0300 | 0.635 | 0.762 | |
| D | .386 | .393 | 9.80 | 9.98 | 28 AF |
| S | .0250 | .0300 | 0.635 | 0.762 | |

NOTES:

- 1). D & E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
- 2). MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .006" PER SIDE.
- 3). CONTROLLING DIMENSIONS: INCHES.
- 4). MEETS JEDEC MO137.

 **DALLAS SEMICONDUCTOR** MAXIM

PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, QSOP .150", .025" LEAD PITCH

| | | |
|----------|----------------------|-------|
| APPROVAL | DOCUMENT CONTROL NO. | REV. |
| | 21-0055 | E 1/1 |

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